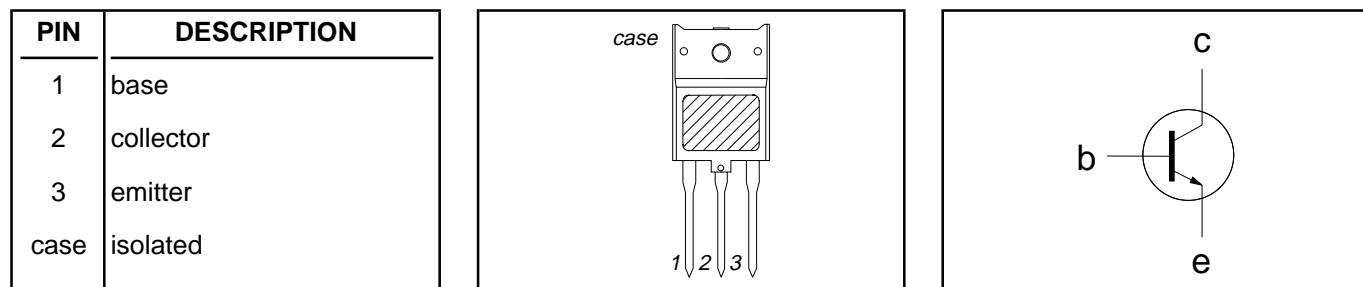


Silicon Diffused Power Transistor**BU2727AX****GENERAL DESCRIPTION**

High voltage, high-speed switching npn transistor in a plastic full-pack envelope intended for use in horizontal deflection circuits of high resolution monitors. Designed to withstand V_{CES} pulses up to 1700V.

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | TYP. | MAX. | UNIT |
|-------------|---------------------------------------|--|------|------|---------------|
| V_{CESM} | Collector-emitter voltage peak value | $V_{BE} = 0 \text{ V}$ | - | 1700 | V |
| V_{CEO} | Collector-emitter voltage (open base) | | - | 825 | V |
| I_C | Collector current (DC) | | - | 12 | A |
| I_{CM} | Collector current peak value | | - | 30 | A |
| P_{tot} | Total power dissipation | | - | 45 | W |
| V_{CEsat} | Collector-emitter saturation voltage | $T_{hs} \leq 25 \text{ }^\circ\text{C}$ | - | 1.0 | V |
| I_{Csat} | Collector saturation current | $I_C = 5.0 \text{ A}; I_B = 0.91 \text{ A}$ | 5.0 | - | A |
| t_s | Storage time | $f = 64 \text{ kHz}$ | 2.5 | 3.0 | μs |
| | | $I_{Csat} = 5.0 \text{ A}; f = 64\text{kHz}$ | | | |

PINNING - SOT399**PIN CONFIGURATION****SYMBOL****LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--------------|--|---|------|------|------------------|
| V_{CESM} | Collector-emitter voltage peak value | $V_{BE} = 0 \text{ V}$ | - | 1700 | V |
| V_{CEO} | Collector-emitter voltage (open base) | | - | 825 | V |
| I_C | Collector current (DC) | | - | 12 | A |
| I_{CM} | Collector current peak value | | - | 30 | A |
| I_B | Base current (DC) | | - | 12 | A |
| I_{BM} | Base current peak value | | - | 20 | A |
| $-I_{B(AV)}$ | Reverse base current | average over any 20 ms period | - | 200 | mA |
| $-I_{BM}$ | Reverse base current peak value ¹ | | - | 9 | A |
| P_{tot} | Total power dissipation | | - | 45 | W |
| T_{stg} | Storage temperature | $T_{hs} \leq 25 \text{ }^\circ\text{C}$ | -65 | 150 | $^\circ\text{C}$ |
| T_j | Junction temperature | | - | 150 | $^\circ\text{C}$ |

ESD LIMITING VALUES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--------|---|--|------|------|------|
| V_c | Electrostatic discharge capacitor voltage | Human body model (250 pF, 1.5 k Ω) | - | 10 | kV |

¹ Turn-off current.

Silicon Diffused Power Transistor

BU2727AX

THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | TYP. | MAX. | UNIT |
|----------------|----------------------|---------------------------|------|------|------|
| $R_{th\ j-hs}$ | Junction to heatsink | without heatsink compound | - | 3.7 | K/W |
| $R_{th\ j-hs}$ | Junction to heatsink | with heatsink compound | - | 2.8 | K/W |
| $R_{th\ j-a}$ | Junction to ambient | in free air | 35 | - | K/W |

ISOLATION LIMITING VALUE & CHARACTERISTIC $T_{hs} = 25^\circ C$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------|---|---------------------------------------|------|------|------|------|
| V_{isol} | Repetitive peak voltage from all three terminals to external heatsink | R.H. $\leq 65\%$; clean and dustfree | - | | 2500 | V |
| C_{isol} | Capacitance from T2 to external heatsink | $f = 1\text{ MHz}$ | - | 22 | - | pF |

STATIC CHARACTERISTICS $T_{hs} = 25^\circ C$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------|--|---|------|------|------|------|
| I_{CES} | Collector cut-off current ² | $V_{BE} = 0\text{ V}; V_{CE} = V_{CESMmax}$ | - | - | 1.0 | mA |
| I_{CES} | | $V_{BE} = 0\text{ V}; V_{CE} = V_{CESMmax}$ | - | - | 2.0 | mA |
| I_{EBO} | Emitter cut-off current | $T_j = 125^\circ C$ | - | - | 1.0 | mA |
| BV_{EBO} | Emitter-base breakdown voltage | $V_{EB} = 7.5\text{ V}; I_B = 0\text{ A}$ | 7.5 | 13.5 | - | V |
| $V_{CEO}sust$ | Collector-emitter sustaining voltage | $I_B = 1\text{ mA}$ | 825 | - | - | V |
| V_{CEsat} | Collector-emitter saturation voltage | $I_B = 0\text{ A}; I_C = 100\text{ mA}; L = 25\text{ mH}$ | - | - | 1.0 | V |
| V_{BEsat} | Base-emitter saturation voltage | $I_C = 5.0\text{ A}; I_B = 0.91\text{ A}$ | - | - | 1.0 | V |
| h_{FE} | DC current gain | $I_C = 5.0\text{ A}; I_B = 0.91\text{ A}$ | - | - | - | V |
| h_{FE} | | $I_C = 0.1\text{ A}; V_{CE} = 5\text{ V}$ | - | 22 | - | V |
| | | $I_C = 5\text{ A}; V_{CE} = 1\text{ V}$ | 5.5 | 8 | 11 | V |

DYNAMIC CHARACTERISTICS $T_{hs} = 25^\circ C$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | TYP. | MAX. | UNIT |
|--------|--|---|-------------|-------------|---------------|
| t_s | Switching times (64 kHz line deflection circuit) | $I_{Csat} = 5.0\text{ A}; L_C = 260\text{ }\mu\text{H}; C_{fb} = 4.8\text{ nF}; V_{CC} = 180\text{ V}; I_{B(end)} = 0.9\text{ A}; I_B = 0.6\text{ }\mu\text{H}; -V_{BB} = 2\text{ V}; (-dI_B/dt = 3.33\text{ A}/\mu\text{s})$ | | | |
| t_f | Turn-off storage time Turn-off fall time | | 2.5 0.30 | 3.0 0.39 | μs |

² Measured with half sine-wave voltage (curve tracer).

Silicon Diffused Power Transistor

BU2727AX

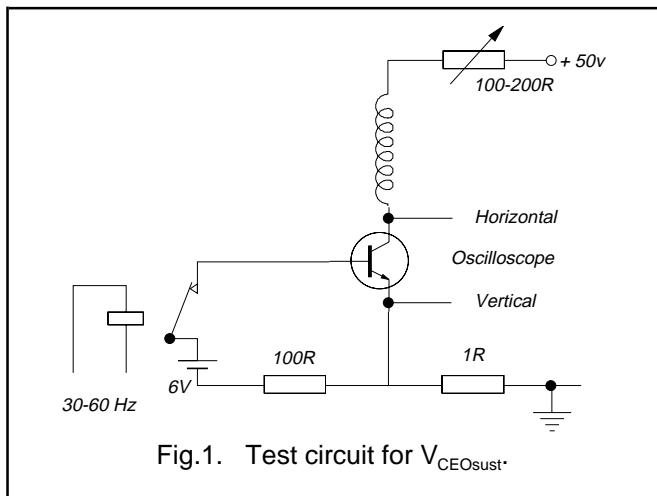
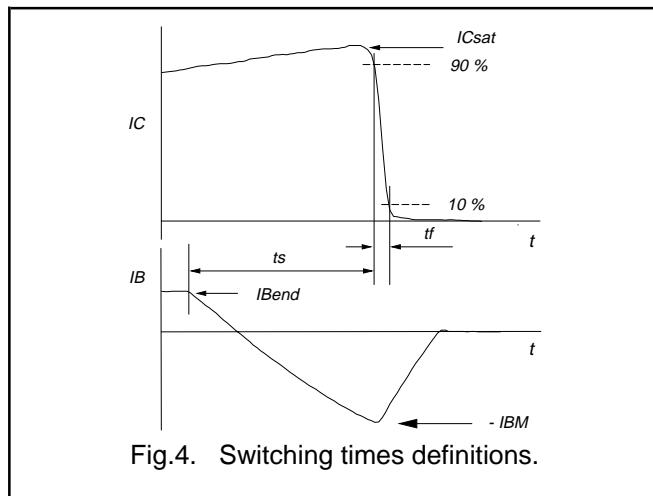
Fig.1. Test circuit for $V_{CEO}sust$.

Fig.4. Switching times definitions.

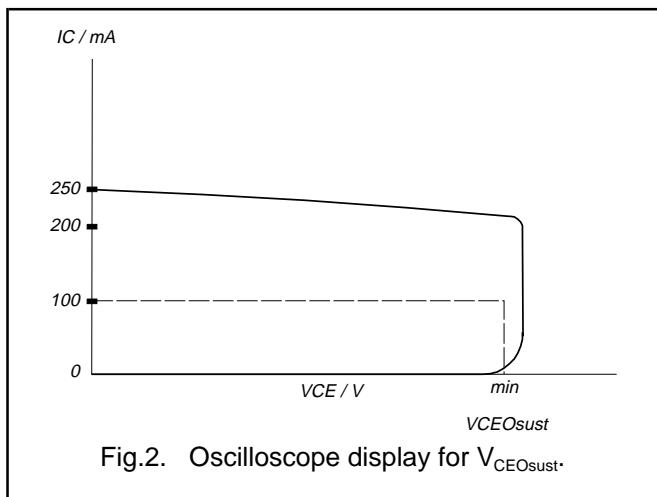
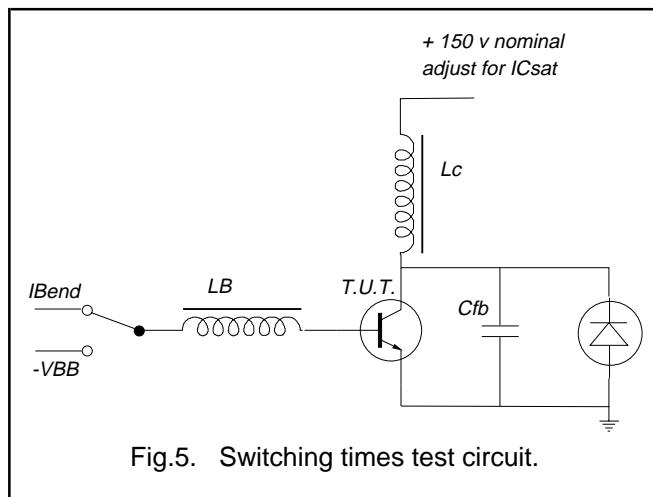
Fig.2. Oscilloscope display for $V_{CEO}sust$.

Fig.5. Switching times test circuit.

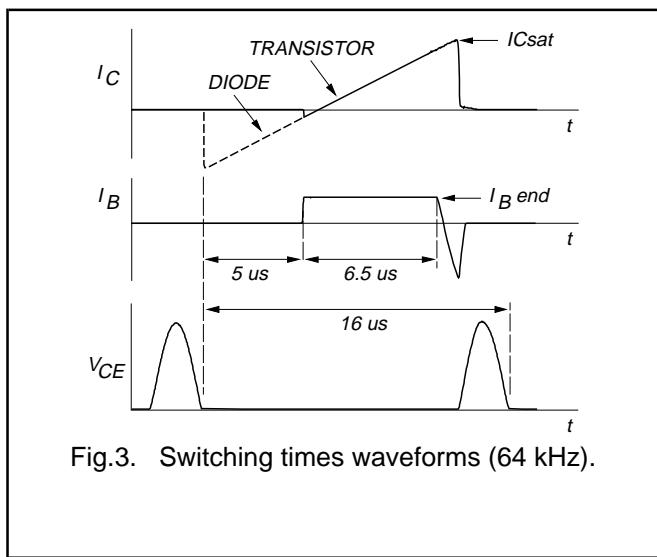
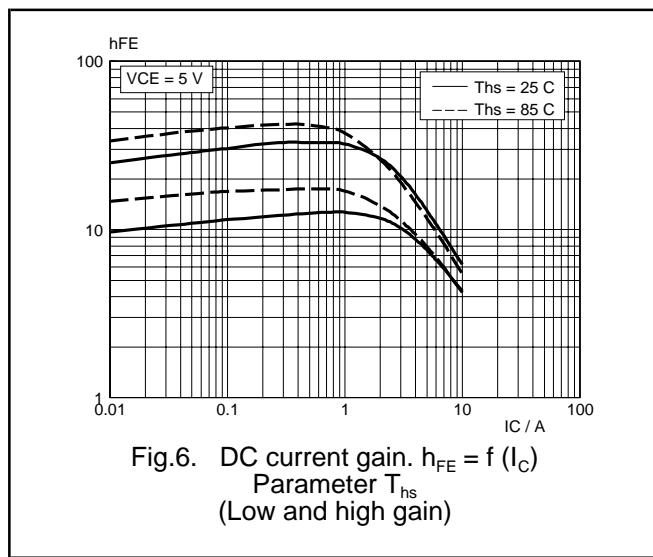


Fig.3. Switching times waveforms (64 kHz).

Fig.6. DC current gain. $h_{FE} = f (I_C)$
Parameter T_{hs}
(Low and high gain)

Silicon Diffused Power Transistor

BU2727AX

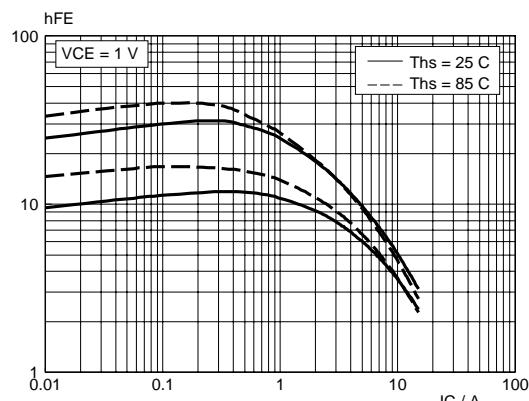


Fig.7. DC current gain. $h_{FE} = f(I_C)$
Parameter T_{hs}
(Low and high gain)

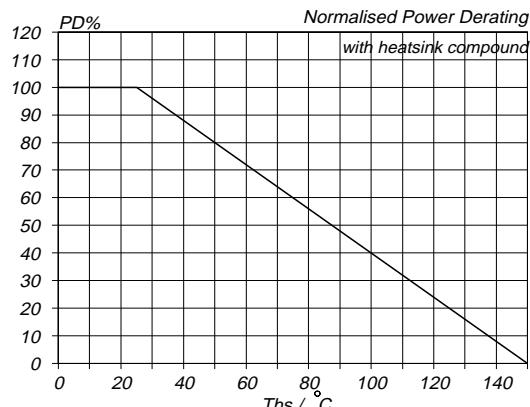


Fig.10. Normalised power dissipation.
 $PD\% = 100 \cdot PD/PD\ 25^\circ C = f(T_{hs})$

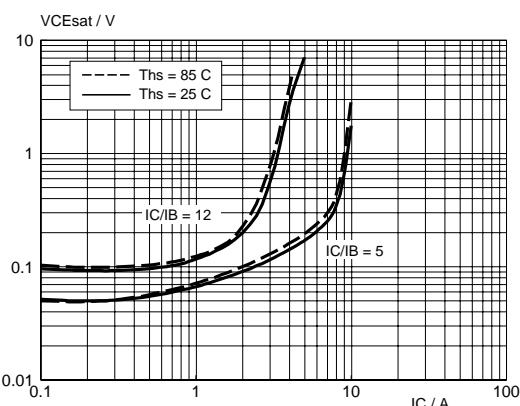


Fig.8. Typical collector-emitter saturation voltage.
 $V_{CEsat} = f(I_C)$; parameter I_C/I_B

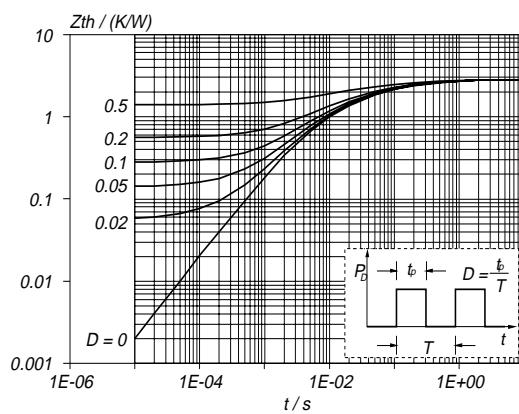


Fig.11. Transient thermal impedance.
 $Z_{th(j-hs)} = f(t)$; parameter $D = t_p/T$

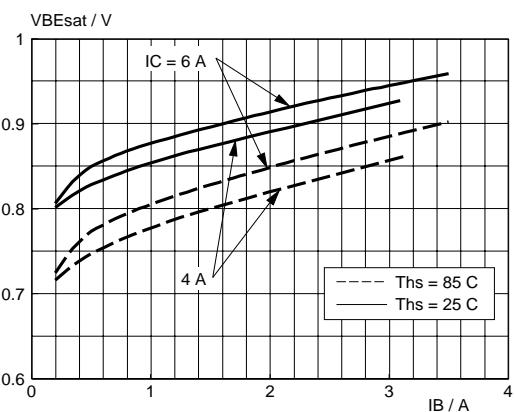


Fig.9. Typical base-emitter saturation voltage.
 $V_{BEsat} = f(I_B)$; parameter I_C

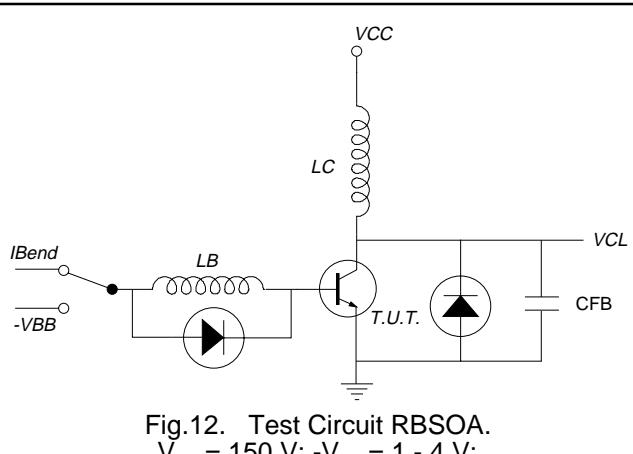
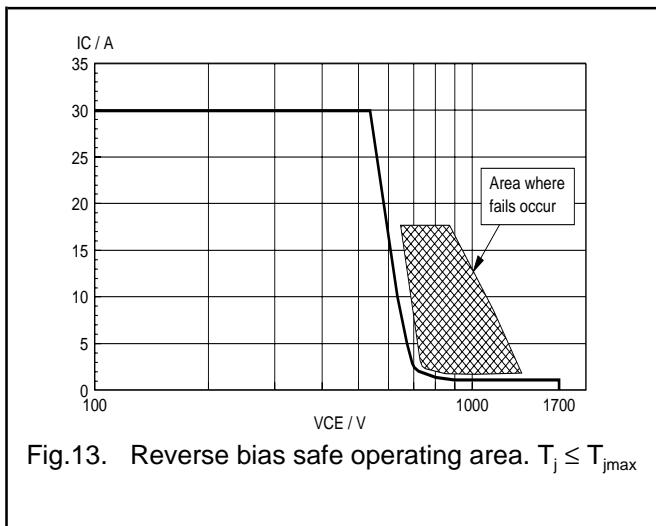


Fig.12. Test Circuit RBSOA.
 $V_{CC} = 150\ V$; $-V_{BB} = 1 - 4\ V$;
 $L_C = 1\ mH$; $V_{CL} = 1500\ V$; $L_B = 0.5 - 2\ \mu H$;
 $C_{FB} = 1 - 3\ nF$; $I_{B(end)} = 0.8 - 4\ A$

Silicon Diffused Power Transistor

BU2727AX



Silicon Diffused Power Transistor

BU2727AX

MECHANICAL DATA

Dimensions in mm

Net Mass: 5.88 g

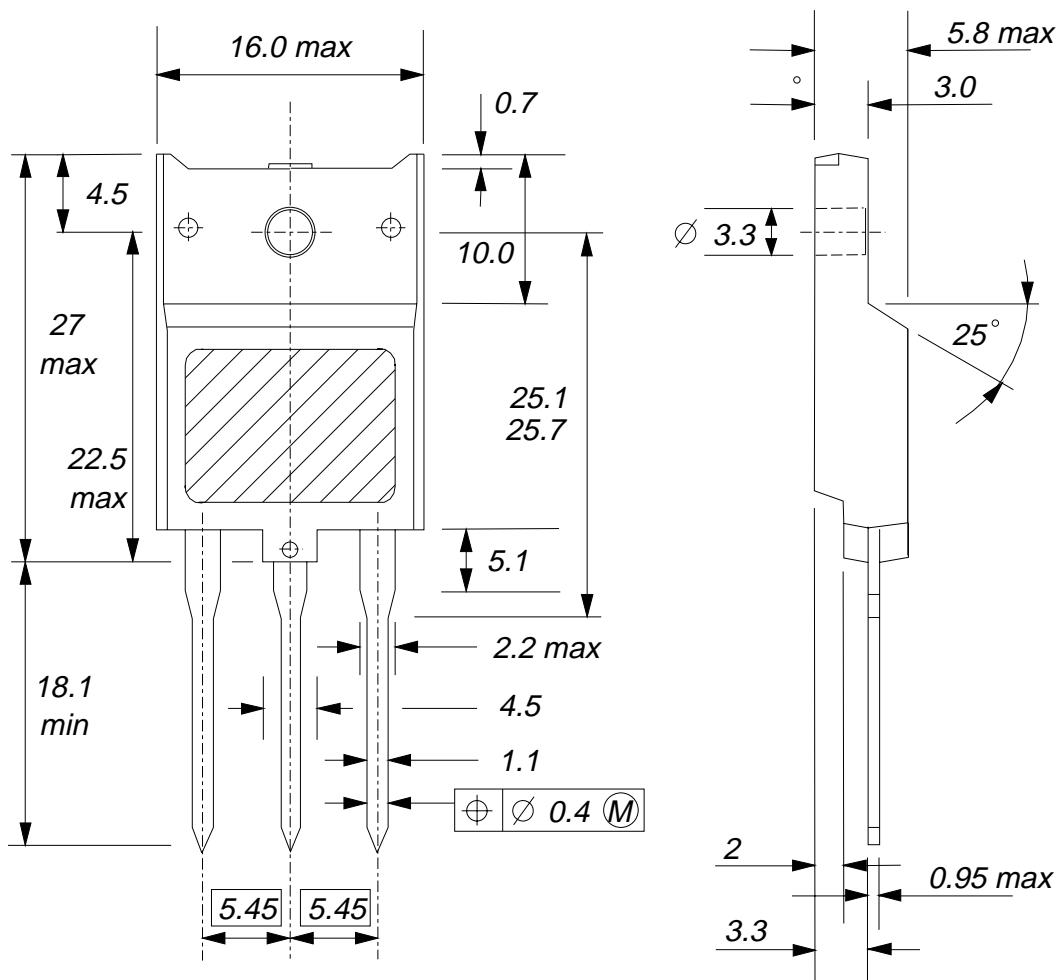


Fig.14. SOT399; The seating plane is electrically isolated from all terminals.

Notes

1. Refer to mounting instructions for F-pack envelopes.
2. Epoxy meets UL94 V0 at 1/8".

Silicon Diffused Power Transistor**BU2727AX****DEFINITIONS**

| Data sheet status | |
|--|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |
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